PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YEN-LIANG WU	11/13/2014
CHUNG-FU CHANG	11/13/2014
WEN-JIUN SHEN	11/13/2014
MAN-LING LU	11/13/2014
CHIA-JONG LIU	11/13/2014
YI-WEI CHEN	11/13/2014

RECEIVING PARTY DATA

Name:	UNITED MICROELECTRONICS CORPORATION	
Street Address:	NO. 3, LI-HSIN RD. II,	
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14549523

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2816688988

Email: dean.foresight@gmail.com

Correspondent Name: DING YU TAN

Address Line 1: 20806 FIGURINE COURT Address Line 4: KATY, TEXAS 77450

ATTORNEY DOCKET NUMBER:	13419UMC-US
NAME OF SUBMITTER:	DING YU TAN
SIGNATURE:	/Ding Yu Tan/
DATE SIGNED: 11/20/2014	
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 4

REEL: 034225 FRAME: 0332

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> PATENT REEL: 034225 FRAME: 0333

Declaration (37 CFR 1.63) for Utility Patent Application Using An Application Data Sheet (37 CFR 1.76) and Assignment For Single Assignee

The title of the invention is as follow:

FINFET STRUCTURE

As a below named inventor, I hereby declare that this declaration is directed to the application of which is attached hereto unless the following box is checked:

was filed on ______ as United States Application Number or PCT International Application Number

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, ___United Microelectronics Corporation ____ (hereinafter referred to "Assignee") whose mailing address is ____ NO. 3, LI-HSIN RD. II, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU, TAIWAN ____ is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

Now, therefore, in consideration of the sum of One dollars (\$ 1.00), the receipt whereof is acknowledged, and for other good and valuable consideration, I, by these presents hereby do sell, assign and transfer unto said Assignee the entire right, title, and interest in and to any and all improvements which are disclosed in said invention and, in and to, all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all continuations, continuation-in-part, divisions, renewals, substitutions, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.

I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Assignee as the assignee of my entire right, title and interest in and to the same, for the sole use and behoof of said Assignee, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made.

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Further, I agree that I will communicate to said Assignee or its (his) representatives any facts

known to me respecting said invention, and testify in any legal proceeding, sign all lawful

papers, execute all divisional, continuation, substitute, renewal and reissue applications,

execute all necessary assignment papers to cause any and all of said Letters Patent to be

issued to said Assignee, make all rightful oaths, and, generally do everything possible to aid

said Assignee, its (his) successors and assigns, to obtain and enforce proper protection for

said invention in the United States and its territorial possessions and in any and all foreign

countries.

I hereby acknowledge that any willful false statement made in this declaration is punishable

under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Direct all Correspondence to:

The Address Associated with Customer Number 66749

Legal Name of Sole or First Inventor:	
YEN-LIANG WU	
Inventor's signature	Date
Yen-Gong Wu.	NOV 1 3 201 4
Legal Name of Additional Joint Inventor, if any:	
CHUNG-FU CHANG	
Inventor's signature	Date
Chang-tow chang	NOV 1 3 2014
Legal Name of Additional Joint Inventor, if any:	
WEN-JIUN SHEN	
Inventor's signature	Date
WEN-JIUN SHEN	NOV 1 3 2014
Legal Name of Additional Joint Inventor, if any:	
MAN-LING LU	
Inventor's signature	Date
Man-ling Lu	NOV 1 3 2014
Legal Name of Additional Joint Inventor, if any:	
CHIA-JONG LIU	
Inventor's signature	i
Onia-Joury Sax	NOV 1 3 2014
/}	

X Additional inventors are being named on the next page, if any

Legal Name of Additional Joint Inventor, if any:	
YI-WEI CHEN	
Inventor's signature	Date
You doe don	NOV 1 3 2014

Additional inventors are being named on the next page, if any